

# HEAD OF DELEGATION (HoD) REPORT

U.S. Member Body of the International Organization for Standardization (ISO)



U.S. National Committee of the International Electrotechnical Commission (IEC)

Please return this report within one month of the completion of the international meeting and submit it to the appropriate ANSI Department as follows:

<u>USNC</u>

<u>ISOT@ansi.org</u> <u>USNC@ansi.org</u>

HoD reports can be used for a variety of purposes. For example:

- ❖ To report results of a TC/SC meeting to the related TAG
- ❖ To publicize the work of the TC/SC to the related US constituency via ANSI On-line, USNC News and Notes, or other media
- **❖** To suggest areas for possible development of featured articles
- **❖** To address specific challenges and concerns that the HoD may bring to the attention of related ANSI and/or USNC/IEC management

PLEASE REMEMBER: Your HoD report is NOT filed as a confidential, password protected document and, therefore, may have broad, unintended distribution. Keep this in mind when preparing the report and, if appropriate, use a more secure form of correspondence to call attention to any sensitive issues.

### Completed by:

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Date:	2015-01-09			

Meeting of TC86/Fibre Optics	
(Designation/Title)	
Date(s) 2014-11-12	
Location Tokyo, Japan	

	Please indicate, if available, both the number of delegates and the countries represented at the Meeting:
	53 delegates from 18 countries
	_X_ Meeting attendance roster and meeting resolutions attached, if available
	Please comment on significant or unusual attendance issues (e.g., new member bodies, regular members not in attendance, new Chairman or Secretariat, non-accredited U.S. persons, etc.).
	MEETING OBSERVATIONS
2.	Overall, how well did the U.S. meet its objectives on policy or technical matters?
	_X_ Very Successful U.S. positions were accepted in whole Successful Compromises were reached which are acceptable to the U.S Not Successful U.S. positions were not accepted
3.	Please comment on any issues of significance which might have an impact upon materially affected or interested U.S. parties.
	None in particular.
4.	Was there any discussion for which the United States was unprepared? (e.g., late document distribution, addition of new items, etc.)
	No.
5.	Did the U.S. extend an offer to assume any new TC/SC Secretariat or management positions?
	YesX No (If yes, please indicate which position and provide Officer contact information.)
6.	Did the U.S. extend an offer to host any future TC/SC meetings?
	YesX_ No If yes, please identify:
7.	Were any new issues raised which require, or might involve, coordination with other U.S. bodies? (Include coordination items with other U.S. TAGs, ANSI policy-level committees (AIF, AIC, the USNC TMC and/or Council, etc.)

1.

MEETING ATTENDANCE

	Yes _X_ No If yes, please identify:
8.	Did the U.S. put forth/agree to put forth any New Work Items?
	YesN_ No If yes, please identify:
9.	Was there any evidence of irregular voting by participating countries?
	YesX_ No If yes, please identify any significant issues or concerns:
10.	Are work items in the TC or SC being affected by related work in regional standards bodies (e.g., CEN, CENELEC, ETSI, PASC, NAFTA, COPANT, etc.)?
	YesX_ No No related regional activity If yes, please explain:
11.	Were any new issues raised which require, or might involve, coordination with emerging market countries?
	Yes _X_ No If yes, please explain:
12.	Were any issues raised which relate to or impact existing U.S. regulatory matters?
	YesX_ No If yes, please explain:
13.	Please identify any IMMEDIATE U.S. TAG actions which will be required as a result of this international meeting.
	None
14.	Please identify specific decisions which the U.S. delegation believes to be noteworthy for publication, publicity and/or development of a future article. If there are any, would you be willing to help develop an article for publication? None
	Yes No
15.	What might be done to further promote the ANSI Federation's goal of "global standards that reflect U.S. interests?" (Consider such issues as how might the U.S. further promote acceptance of related American National Standards in international and, where applicable, regional fora?)

16.	Has this report been pr	vided to your TAG Administrator for US TAG	distribution?
	Yes	_X_ No	
17.	Other Comments		

January 2015

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